LBI-39164

MAINTENANCE MANUAL ORIONTM (Dual Bandwidth)

UHF POWER AMPLIFIER UNITS

344A4573P1	20 WATT	403-440 MHz
344A4573P2	20 WATT	440-470 MHz
344A4573P3	40 WATT	403-440 MHz
344A4573P4	40 WATT	440-470 MHz
344A4573P5	35 WATT	470-512 MHz
344A4573P6	100 WATT	403-440 MHz
344A4573P7	100 WATT	440-470 MHz
344A4573P8	80 WATT	470-512 MHz

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20-WATT POWER AMPLIFIER
35/40-WATT POWER AMPLIFIER
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20-WATT POWER AMPLIFIER
35/40-WATT POWER AMPLIFIER
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DESCRIPTION

The Radio Frequency (RF) Power Amplifiers for the UHF **ORION**TM mobile radio are provided in three different frequency ranges and power levels designated as follows:

- 344A4573P1 (CAH-545EA) 403-440 MHz, 20 WATT used in low power applications 344A4573P2 (CAH-545EB) 440-470 MHz, 20 WATT used in low power applications
- 344A4573P3 (CAH-545AL) 403-440 MHz, 40 WATT used in mid power applications 344A4573P4 (CAH-545BL) 440-470 MHz, 40 WATT used in mid power applications 344A4573P5 (CAH-545CL) 470-512 MHz, 35 WATT used in mid power applications
- 344A4573P6 (CAH-545AH) 403-440 MHz, 100 WATT used in high power applications
 344A4573P7 (CAH-545BH) 440-470 MHz, 100 WATT used in high power applications
 344A4573P8 (CAH-545CH) 470-512 MHz, 80 WATT used in high power applications

The exciter for each of the three power amplifiers is located on Synthesizer/Receiver/Exciter board CMN-354-1. This exciter circuit provides approximately 500 milliwatt input to the PA (refer to Maintenance Manual LBI- 39163). The PA utilizes a single power amplifier module (HC1) as the driver unit. In the case of the 20 watt amplifier the power module is the only power amplifying unit (Refer to Figure 1). With the other two power levels the power module drives other power transistors to provide the power output required (Refer to Figures 2 and 3). Each power amplifier is provided with an antenna switch and limiter circuit to isolate the receive circuit from the transmit circuit, limiting the receiver input from being over driven due to large RF signals. Each power amplifier has a power detect circuit which controls an Automatic Power Control (APC) circuit to keep the power output constant. A low-pass filter is provided in the antenna circuit to reduce harmonic emissions. A keyed Tx 9V regulator is provided to power the APC cir-

CIRCUIT ANALYSIS

20 WATT

The 20 Watt PA assembly uses one power module (HC1) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Diode CD7 is a surge protector to suppress pulses on the power leads. Diode CD8 will cause the fuse to blow if the polarity of the power leads is reversed.

The Exciter output is coupled through connector J151 on the Synthesizer/Receiver/Exciter Board to input connector J1 on the PA board. The 500 milliwatt RF input at J1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1-R3. This pad attenuates the power to about 300 milliwatt and provides isolation between Exciter and PA. The power module (HC1) amplifies the 300 milliwatt input to 20 Watts.

The power module consists of a three-stage RF amplifier (Refer to **IC DATA**). The first stage power supply voltage is supplied by the power control circuit. The second and third stage power supply voltage is supplied by **SMOOTHING FILTER** transistor TR1. The second and third stage RF amplifiers operate as class C.

The 20 Watts output of HC1 is coupled to the **ANTENNA** and **ANTENNA SWITCH & LIMITER** circuits through 50 ohm stripline Z1.

Antenna Switch & Limiter

The Antenna Switch circuit consists of capacitor C25 and inductor L9 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD3 and CD4. A low impedance now exists at the anode of CD4 and a high impedance exists at the node connection of C25 and L9. This isolates the transmitter power from the receiver. Diode CD3 is now an RF short and along with capacitor C12, couples the power to the lowpass filter and on to the antenna.

The limiter circuit consists of transistors TR7, TR8 and diode package CD13. While receiving, if the received signal level exceeds +10 dBm, the rectified currents of CD13 provide forward bias to TR7, TR8 and PIN diode CD4 proportional to the received signal level. This causes a quarter-wave circuit (lumped constants C25 and L9) to turn on when the received signal exceeds +10 dBm and protects the receiver from excessively high receive signal levels.

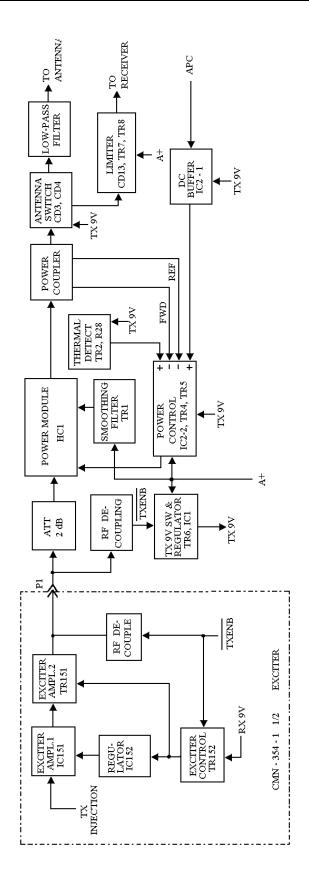


Figure 1 - 20-Watt Power Amplifier Block Diagram

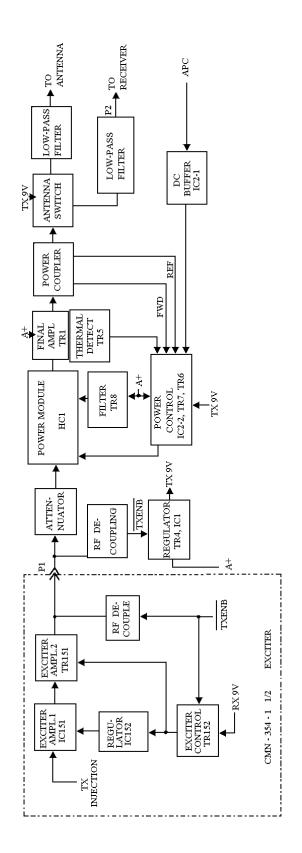


Figure 2 - 35/40-Watt Power Amplifier Block Diagram

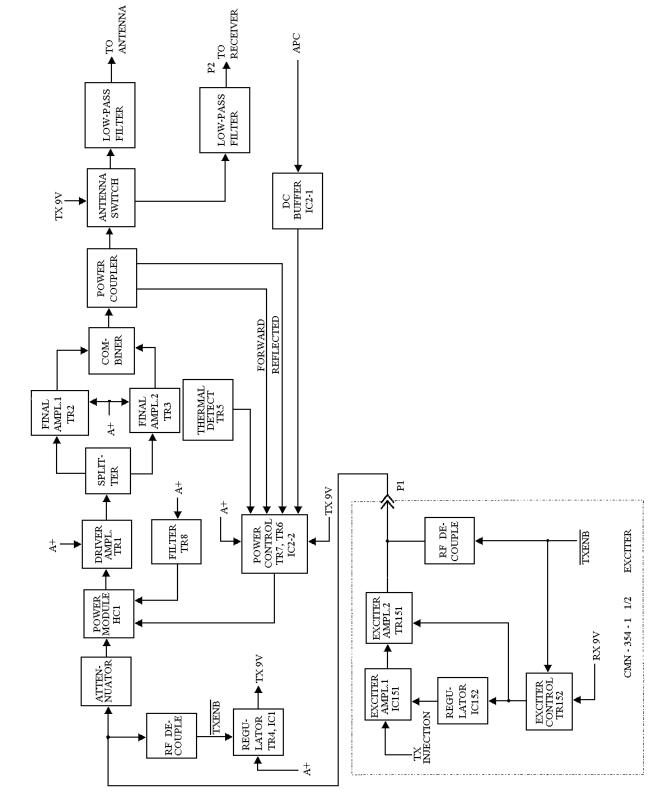


Figure 3 - 80/100 - Watt Power Amplifier Block Diagram

Tx 9V Switch

When the lead, located on the Synthesizer/Receiver/Exciter board, goes low, the DC voltage on J151 goes low. On the PA board, the DC voltage on J1 also goes low completing the circuit for diode CD9. With CD9 conducting TX 9V Switch transistor TR6 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts applies bias to operational amplifier IC2, transistor TR2 and switching diodes CD3 and CD4.

Power Control

The Auto Power Control (APC) circuit protects the transmitter PA from damage due to:

- a. excessive output power
- b. excessive reflected power
- c. excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the Logic/IF/Audio Board. If the output power of the PA increases, the detected voltage and the input to operational amplifier IC2-2 increases. The output voltage of operational amplifier IC2-2 decreases. This causes **DC DRIVER** transistor TR5 to conduct less. This increases the base voltage on PNP **DC PASS** transistor TR4, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in RF Power Module HC1, reducing the output power of the PA in proportion to the increases in output power detected by the circuit.

To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD2, transistor TR5, operational amplifier IC2-2 and pass transistor TR4 detects reverse (reflected) power. When sufficient power is detected by CD2 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the Power Module to lower the output power, protecting the PA. The reverse power level is set by resistor R8 connected in series with diode CD2.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R28, **THERMAL DETECT** transistor TR2, **DC DRIVER** transistor TR5 and **DC AMPL** operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R28 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R28. When the heatsink temperature rises above 90 C, the resistance of R28 increases and the power output is reduced.

35/40 WATT

The 35/40 Watt PA assembly uses one power module (HC1) and one RF power transistor (TR1) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Diode CD2 is a surge protector to suppress pulses on the power leads. (Diode CD1001 in the PA UNIT will cause a fuse to blow if the voltage polarity is reversed. Refer to the PA INTERCONNECTION DIAGRAM)

Test Points (TP) are the printed board terminals for measuring control voltage as follows:

- TP1 A+ (13.42V)
- TP2 Control Voltage (4.72V)
- TP3 Forward Power Detect (2.64V)
- TP4 Tx 9V (9.12V)
- TP5 APC Voltage on output of DC AMPL IC2-1 (2.64V)
- TP6 Voltage to HC1, pins 3 &4 (12.5V)
- TP7 APC Voltage (3.5V)

The Exciter output is coupled through connector J151 on the Synthesizer/Receiver/Exciter Board to input Jack P1 on the PA board. The 500 milliwatt RF input at P1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1-R4. This pad attenuates the 500 milliwatt to about 300 milliwatt and provides isolation between Exciter and PA. The power module (HC1) amplifies the 300 milliwatt input to 13 Watts.

The power module consists of a three-stage RF amplifier (Refer to IC DATA). The first stage power supply voltage is supplied by the power control circuit. The second and third stage power supply voltage is supplied by **SMOOTHING FILTER** transistor TR8. The second and third RF amplifiers operate as class C.

The 13 Watts output of HC1 is coupled to **POWER AMPL** transistor TR1 through impedance matching components consisting of capacitors C7, C9, C10 and inductor L2 through coupling capacitor C8. Transistor TR1 amplifies the 13 Watt level to 40 Watts. The output of TR1 is coupled to the **ANTENNA** and **ANTENNA SWITCH** through impedance matching components consisting of capacitors C11-C13, inductor L6 and impedance matching network Z2 through coupling capacitor C14 and 50 ohm stripline Z7.

Antenna Switch

The Antenna Switch circuit consists of capacitor C64 and inductor L23 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD5, CD7 and CD9. A low impedance now exists at the anode of CD7 and a high impedance exists at the connection of C64 and L23. This isolates the transmitter power from the receiver. Diode CD5 is now an RF short and along with capacitor C55 couples the power to the lowpass filter and on to the antenna.

Tx 9V Switch

When the **TX ENB** lead goes low, TX 9V switch transistor TR4 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts (**TX 9V**) applies bias to operational amplifier IC2, transistor TR5 and switching diodes CD5, CD7 and CD9.

Power Control

The Auto Power Control (APC) circuit protects the transmitter PA from damage due to:

- a. excessive output power
- b. excessive reflected power
- c. excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the Logic/IF/Audio Board. If the output power of the PA increases, the detected voltage and the input of operational amplifier IC2-2 increases. The output voltage of IC2-2 decreases. This causes **DC DRIVER** transistor TR6 to conduct less. This increases the base voltage on PNP **DC PASS** transistor TR7, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in driver module (HC1), reducing the output power of the PA in proportion to the increases in output power detected by the circuit

To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD4, transistor TR6, operational amplifier IC2-2 and pass transistor TR7 detects reverse (reflected) power. When sufficient power is detected by CD4 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the driver module to lower the output power, protecting the PA. The reverse power level is set by resistor R15 connected in series with diode CD4.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R49, transistors TR5, TR6, TR7 and operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R49 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R49. When the heatsink temperature rises above 90 C, the resistance of R49 increases and the power output is reduced.

80/100 WATT

The 80/100 Watt PA assembly uses one power module (HC1) and three RF power transistors (TR1, TR2 and TR3) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Capacitors C73 and C95 prevent RF from getting on the power leads. Diode CD1 causes a fuse to blow if the polarity of the power leads is reversed. Diode CD2 is a surge protector to suppress pulses on the power leads

Test Points (TP) are the printed board terminals for measuring control voltage as follows:

- TP1 A+ (13.32V)
- TP2 Control Voltage (4.27V)
- TP3 Forward Power Detect (3.2V)
- TP4 Tx 9V (9.2V)
- TP5 APC Voltage on output of DC AMPL IC2-1 (2.66V)
- TP6 Voltage to HC1, pins 3 &4 (12.8V)
- TP7 APC Voltage (3.5V)

The exciter output is coupled through connector J102 on the Synthesizer/Receiver/Exciter Board to input Jack P1 on the PA board. The 500 milliwatt RF input at P1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1 through R4. This pad attenuates the 500 milliwatt input to 300 milliwatt and provides isolation between the Exciter and PA. **POWER MODULE** HC1 amplifies the 300 milliwatt input to 12 Watts. The power module (HC1) consists of a three stage RF amplifier. The first stage of the module is controlled by the voltage from the power control circuit. The amplifier consist of a Class C driver amplifier and two Class C common-emitter amplifiers. The 12 watt output is coupled to **DRIVER AMPL** transistor TR1 through impedance matching components consisting of capacitors C7, C9 C10, inductors L2 through L4 and coupling

capacitor C8. The output of TR1 is coupled to the power **SPLITTER** through the impedance matching components consisting of capacitors C11 through C13, C15, C96, C97, inductor L6 and impedance matching network Z1 through coupling capacitor C14. Transistor TR1 amplifies the 12 watt input level to 40 watts. The power splitter consists of capacitors C18, C27, C36 and Inductors L7 and L11. Resistor R5 absorbs any unbalance in the drive to POWER AMPL-1, AMPL-2 transistors TR2 and TR3. These power amplifier stages consist of two identical paralleled Class C power amplifiers. The output of the power splitter is coupled to transistors TR2 and TR3 through coupling capacitors C19 and C28 and the impedance matching components consisting of capacitors C20, C21, C29 and C30. The output of TR2 and TR3 is coupled to the power combiner through impedance matching components consisting of capacitors C22-C25, C31-C34 and impedance matching networks Z2 and Z3. The power **COMBINER** consists of capacitors C26, C35, C40, C41 and inductors L10, L14 and L15. Resistor R8 absorbs the difference in the output power of TR2 and TR3. Transistors TR2 and TR3 each amplify the input level from 20 watts to about one-half (1/2) of the rated output power. The output of the combiner is coupled to the ANTENNA **SWITCH** through 50 ohm stripline Z7.

Antenna Switch

The antenna switch circuit consists of capacitor C64 and inductor L23 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD6 through CD9. A low impedance now exists at the anode of CD7 and CD8 and high impedance exists at the connection of C64 and L23. This isolates the transmitter power from the receiver. Diode CD6 is now an RF short and along with capacitor C55 couples the power to the lowpass filter and on to the antenna.

Tx 9V Switch

When the TX ENB lead goes low, TX 9V switch transistor TR4 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts (TX 9V) applies bias to operational amplifier IC2, transistor TR5 and switching diodes CD6 through CD9.

Power Control

The Automatic Power Control (APC) circuit protects the transmitter PA from damage due to:

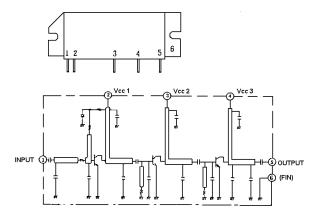
- a. excessive output power
- b. excessive reflected power
- c. excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the LOGIC/IF/AUDIO Board. If the output power of the PA increases, the detected voltage and the input of operational amplifier IC2-2 increases. The output voltage of operational amplifier IC2-2 decreases. This causes transistor TR6 to conduct less. This increases the base voltage on PNP pass transistor TR7, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in driver module (HC1), reducing the output power of the exciter/ PA in proportion to the increases in output power detected by the circuit.

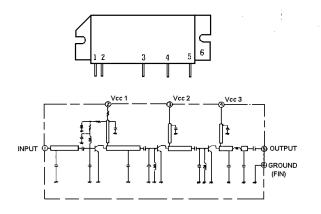
To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD4, transistor TR6, operational amplifier IC2-2 and pass transistor TR7 detect reverse (reflected) power. When sufficient power is detected by CD4 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the driver module to lower the output power, protecting the PA. The reverse power level is set by resistor R15 connected in series with diode CD4.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R49, transistors TR5, TR6, TR7 and operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R49 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R49. When the heatsink temperature rises above 90 C, the resistance of R49 increases and the power output is reduced.

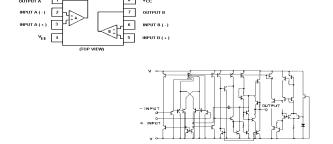
403-512 MHz, 20-WATT POWER MODULE HC1



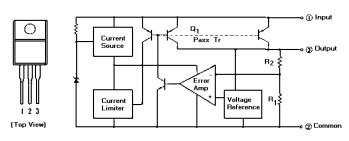
403-512 MHz, 35/40 -WATT POWER MODULE HC1



OPERATIONAL AMPLIFIER IC2



9 VOLT REGULATOR IC1



PA UNIT (EUROPEAN MODEL) 344A4573P1/JHM-471EA, 344A4573P2/JHM-471PEB

SYMBOL	PART NO.	DESCRIPTION
A1001	Note: Parts listed	PA CIRCUIT CAH-545EA (Used in P1)
A1001	are for reference	PA CIRCUIT CAH-545EB (Used in P2)
A1002	only. Refer to	INTERFACE CMH-1231E
	Service Section for	CAPACITORS
C1001	serviceable parts.	Ceramic: 1000 pF +50%, -20% 50 VDCW temp coef ±15%.
and		
C1002		
J1001		H-6JALD00005
TB1001		ALB-01A
		COAXIAL CABLES
W1001		250V-HV-19/0.18-(2).
ZC1002		H-6JJLD25150
ZC1003		H-6JJLD27076
ZC1004		H-6ZCLD41060

PA UNIT (USA MODEL)

344A573P3/JHM-471PAL 344A573P4/JHM-471PBL 344A4573P5/JHM-471PCL 344A4573P6/JHM-471PAH 344A4573P7/JHM-471PBH 344A4573P8/JHM-471PCH

SYMBOL	PART NO.	DESCRIPTION
A1001	Note: Parts listed	PA CIRCUIT CAH-545AL (Used in P3)
A1001	are for reference	PA CIRCUIT CAH-545BL (Used in P4)
A1001	only. Refer to	PA CIRCUIT CAH-545CL (Used in P5)
A1001	Service Section for	PA CIRCUIT CAH-545AH (Used in P6)
A1001	serviceable parts.	PA CIRCUIT CAH-545BH (Used in P7)
A1001		PA CIRCUIT CAH-545CH (Used in P8)
A1002		INTERFACE (Used in P3, P4, P5)
A1002		INTERFACE (Used in P6, P7, P8)
		CAPACITORS
C1001		Ceramic: 1000 pF +200%, -0%, 50 VDCW temp coef +20%,-55%.
C1002		Ceramic: 1000 pF +200%, -0%, 50 VDCW temp coef +20%, -55%. (Used in P6, P7, P8)
C1004		Ceramic: 1000pF +50 -20% 50 VDCW.
CD1001		Silicon fwd current 3A, 200 PIV ;sim to MOTOROLA MR751. (Used in P3, P4, P5)
J1001		Connector: TNC-R888.
J1002		CCT9402-0501R.
J1004		Connector And Wires (Used in P3, P4, P5)
J1004		Connector And Wires (Used in P6, P7, P8)
ZC1002		H-6ZCLD41060
ZC1003		H-6ZCLD40111 (Used in P6, P7, P8)
ZC1003		H-6ZCLD40009 (Used in P3, P4, P5)
TB1001		ALB-01A (Used in P6, P7, P8)

POWER AMPLIFIER CIRCUIT (EUROPEAN) CAH-545E - 20 WATT CAH-545EA (Used in 344A4573P1) CAH-545EB (Used in 344A4573P2)

SYMBOL	PART NO.	DESCRIPTION
0.1		
C1 and	Note: Parts listed	Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C2	are for reference only. Refer to	
C3	Service Section for	Electroytic: 33 μF ±20% 25 VDCW, temp coef ±20%.
C4	serviceable parts.	Film: 0.1 μF ±10% 50 VDCW, temp coef ±15%.
C5		Ceramic: 4.7 μF 20% 35 VDCW, temp coef ±10%.
C7		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C8		Ceramic: 7 pF ±0.5 pF 50 VDCW, temp coef 0±30 PPM. (Used in P1).
C8		Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in P2).
C11		Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in P1).
C11		Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in P2).
C12		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C13		Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM.
and		
C14		
C15		Ceramic: 2 pF ±0.25 PF 500 VDCW, temp coef 0±250 PPM.
C16		Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM.
C17		Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM.
C19		Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 060 PPM.
C20		Ceramic: 2 pF ±0.25 PF 500 VDCW, temp coef 0±250 PPM.
C21		Electroytic: 220 μF ±20% 25 VDCW, temp coef ±20%.
C21		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
thru		Ceramic. 100 pr ±3 % 30 VDCW, temp coer 0±30 FFW.
C24		
C25		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM.
C26		Ceramic: 4 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM.
C27		Ceramic: 2 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM.
C28		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C30		Tantalum: 4.7 μ F $\pm 20\%$ 25 VDCW.
C31		Electroytic: 10 μ F \pm 20% 25 VDCW, temp coef \pm 20%.
C32		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
and		
C33 C34		Tontolum: 10 ::E ±209/ 16 \/DC\//
C34 C35		Tantalum: $10 \mu F \pm 20\% 16 VDCW$. Ceramic: $100 pF \pm 5\% 50 VDCW$, temp coef $0\pm 30 PPM$.
C35		Ceramic: 100 pF ±5% 50 VDCW, temp coer 0±30 PPM. Tantalum: 1 μF ±20% 16 VDCW.
C36 C37		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C38		Ceramic: 0.1 µF +80%, -20% 25 VDCW, temp coef +30%,
C39		-80%. Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
and		Ceramic. 100 pr ±5% 50 vDCvv, temp coei 0±30 PPM.
C40		
C43		Ceramic: 6 pF ±0.5 pF 500 VDCW, temp coef 0±60 PPM.
C44		Ceramic: 4 pF ±0.25pF 50 VDCW, temp coef 0±30 PPM.
C60		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM.
thru		
C62		DIODES
CD1		Silicon: sim to PANASONIC MA741-TX
and		
CD2 CD3		PIN DIODE: sim to NIHONMEICOM H-6TXLD00001
and		THE DIODE. SHIT TO THE TOTAL DOUGHT I TO TALL DOUGHT
CD4		
CD7		VARISTOR: sim to PANASONIC ERZ-CF2MK220
CD8		Silicon: sim to MOTOROLA MR751
CD9		Silicon: fast recovery (2 diodes in cathode common): sim to
CD13		TOSHIBA ISS184. Silicon: fast recovery : sim to TOSHIBA ISS226.
HC1		RF Power Amplifier: sim to MITSUBISHI M57788L-38
HC1		(Used in P1). RF Power Amplifier: sim to MITSUBISHI M57788H-38
		(Used in P2).
IC1		Linear: Positive Voltage Regulator; sim to PANASONIC AN6541.
IC2		Linear, Dual OP Amp: sim to NEW JRC NJM3404AM-T1.
J1		Connector
and		
J2		Connector
J3		Connector

J4	Note: Parts listed	Connector
L1	are for reference	
L2	only. Refer to	
L3	Service Section for	
and	serviceable parts.	COII. 10 111 I.
L4		
L5		RF Coil: AIRWOUND
thru		THE COMPANIES
L8		
L9		Coil: RF 19 nH.
and		Con. 10 10 10 1
L10		
L11		Coil: RF 0.22 uH.
		RESISTORS
R1		Metal film: 470 ohms ±5%, 100 VDCW 1/10W.
R2		Metal film: 12 ohms ±5%, 200 VDCW 1/4W.
R3		Metal film: 470 ohms ±5%, 100 VDCW 1/10W.
R4		Metal film: 22 ohms ±5%, 200 VDCW 1/2W.
and		
R5		Matal film: 100 above 150/ 050 \/ DOW 414
R6		Metal film: 100 ohms ±5%, 250 VDCW 1W.
R8		Metal film: 100 ohms ±5%, 100 VDCW 1/10W.
R9		Metal film: 47 ohms ±5%, 100 VDCW 1/10W.
and		
R10		
R11		Metal film: 47K ohms ±5%, 200 VDCW 1/8W.
R14		Metal film: 27K ohms ±5%, 100 VDCW 1/10W.
R15		Metal film: 2.7K ohms ±5%, 100 VDCW 1/10W.
R16		Metal film: 390 ohms ±5%, 200 VDCW 1/4W.
R17		Metal film: 470 ohms ±5%, 200 VDCW 1/4W.
R18		Metal film: 1K ohms ±5%, 100 VDCW 1/10W.
R19		Metal film: 2.2K ohms ±5%, 200 VDCW 1/10W.
thru		
R21		
R22		Metal film: 100k ohms ±5%, 100 VDCW 1/10W.
R23		Metal film: 3.3K ohms ±5%, 100 VDCW 1/10W.
R24		Metal film: 4.7k ohms ±5%, 100 VDCW 1/10W.
R25		Metal film: 2.2K ohms ±5%, 100 VDCW 1/10W.
R26		Metal film: 47K ohms ±5%, 100 VDCW 1/10W.
R27		Metal film: 1K ohms ±5%, 100 VDCW 1/10W.
R28		Posistor: sim to MURATA PTH9M04BE222TS2F333.
R35		Metal film: 100 ohms ±5%, 250 VDCW 1W.
		*
R36		Metal film: 10K ohms ±5%, 100 VDCW 1/10W.
RV1		Variable: 10K ohms
		TRANSISTOR
TR1		Silicon, NPN: sim to PANASONIC 2SD1445A.
TR2		Silicon, NPN: sim to NEC 2SD596-T1B DV3.
TR4		Silicon, PNP: sim to PANASONIC 2SB953A.
TR5		Silicon, NPN: sim to NEC 2SD596-T1B DV3.
TR6		Silicon, PNP: sim to NEC 2SB624-T1B BV3.
TR7		Silicon, NPN: sim to NEC 2SD596-T1B DV3.
TR8		Silicon, PNP: sim to NEC 2SB624-T1B BV3.

POWER AMPLIFIER CIRCUIT (USA)

CAH-545L - 35/40 WATT

CAH-545H - 80/100 WATT

CAH-545AL (Used in 344A4573P3), CAH-545BL (Used in 344A4573P4)

CAH-545CL (Used in 344A4573P5), CAH-545AH (Used in 344A4573P6)

CAH-545BH (Used in 344A4573P7), CAN-545CH (Used in 344A4573P8)

SYMBOL	PART NO.	DESCRIPTION
		CAPACITORS
C1	Note: Parts listed	Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
and	are for reference	
C2	only. Refer to	
C3	Service Section for	Electrolytic: 33 μF ±20% 25 VDCW, temp coef ±20%.
C5	serviceable parts.	Ceramic: 0.01 μ F \pm 10% 50 VDCW, temp coef 0 \pm 10%.
C6		Ceramic: 0.1 μF +80%, -20% 50 VDCW, temp coef +30%, -80%.
C7		Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P3, P4, P6).
C7		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P7, P8).
C7		Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P5).
C8		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C9		Ceramic: 56 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P3, P6).

SYMBOL	PART NO.	DESCRIPTION
C9	Note: Parts listed	Ceramic: 47 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C10	are for reference	(Used in P4, P5, P7, P8). Ceramic: 56 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C10	only. Refer to Service Section for	(Used in P3, P6).
C10	serviceable parts.	Ceramic: 43 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P7).
C10		Ceramic: 36 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C10		(Used in P5, P8). Ceramic: 47 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C11		(Used in P4). Metal mica: 56 pF ±5% 100 VDCW.(Used in P6, P7).
C11 C11		Metal mica: 36 pF ±5% 100 VDCW.(Used in P3). Metal mica: 33 pF ±5% 100 VDCW. (Used in P4, P5,
		P8).
C12 C12		Metal mica: 39 pF ±5% 100 VDCW. (Used in P6). Metal mica: 47 pF ±5% 100 VDCW. (Used in P4, P5).
C12		Metal mica: 33 pF ±5% 100 VDCW. (Used in P7, P8).
C12		Metal mica: 51 pF ±5% 100 VDCW. (Used in P3).
C13		Mica: 30 pF ±5% 500 VDCW. (Used in P3, P6).
C13		Mica: 24 pF ±5% 500 VDCW. (Used in P7, P5).
C13		Mica: 27 pF ±5% 500 VDCW. (Used in P4).
C14		Mica: 90 pF ±5% 500 VDCW. (Used in P3, P4, P5).
C14		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C15		Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM. (Used in P6).
C15		Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM. (Used in P7).
C15		Ceramic: 4 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM.(Used in P8).
C16		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C17		Electrolytic: 22 uF ±10% 40 VDCW. (Used in P6, P7, P8).
C18		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P6).
C18		Ceramic: 9 pF ±0.5pF 500 VDCW, temp coef 0±60
C18		PPM. (Used in P7). Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60
C19		PPM. (Used in P8). Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60
C20		PPM. (Used in P6, P7, P8). Mica: 56 pF ±5% 500 VDCW. (Used in P6).
C20		Mica: 47 pF ±5% 500 VDCW. (Used in P7).
C20		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C21		Mica: 47 pF ±5% 500 VDCW. (Used in P6).
C21		Mica: 39 pF ±5% 500 VDCW. (Used in P7).
C21		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C22		Metal mica: 39 pF ±5% 100 VDCW. (Used in P6).
C22		Metal mica: 36 pF ±5% 100 VDCW. (Used in P7).
C22		Metal mica: 33 pF ±5% 100 VDCW. (Used in P8).
C23 C23		Metal mica: 56 pF ±5% 100 VDCW. (Used in P6). Metal mica: 47 pF ±5% 100 VDCW. (Used in P7, P8).
C23 C24		Metal mica: 47 pF ±5% 100 VDCW. (Used in P7, P8). Metal mica: 30 pF ±5% 100 VDCW. (Used in P6).
C24		Metal mica: 24 pF ±5% 100 VDCW. (Used in P7).
C24		Metal mica: 18 pF ±5% 100 VDCW. (Used in P8).
C25		Mica: 90 pF ±5% 500 VDCW. (Used in P6, P7, P8).
C26		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60
C26		PPM. (Used in P6, P7). Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60
C27		PPM. (Used in P8). Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60
C27		PPM. (Used in P6). Ceramic: 9 pF ±0.5pF 500 VDCW, temp coef 0±60
		PPM. (Used in P7).
C27		Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P8).
C28		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C29		Mica: 47 pF ±5% 500 VDCW. (Used in P6).
C29		Mica: 39 pF ±5% 500 VDCW. (Used in P7).
C29		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C30 C30		Mica: 56 pF ±5% 500 VDCW. (Used in P6). Mica: 47 pF ±5% 500 VDCW. (Used in P7).
C30		Mica: 36 pF ±5% 500 VDCW. (Used in P7). Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C30		Metal mica: 56 pF ±5% 100 VDCW. (Used in P6).
C31		Metal mica: 47 pF ±5% 100 VDCW. (Used in P7, P8).
C32		Metal mica: 39 pF ±5% 100 VDCW. (Used in P6).
C32		Metal mica: 36 pF ±5% 100 VDCW. (Used in P7).
C32		Metal mica: 33 pF ±5% 100 VDCW. (Used in P8).
C33		Metal mica: 30 pF ±5% 100 VDCW. (Used in P6).
C33		Metal mica: 24 pF ±5% 100 VDCW. (Used in P7).
C33		Metal mica: 18 pF ±5% 100 VDCW. (Used in P8).

LBI-39164 PARTS LIST

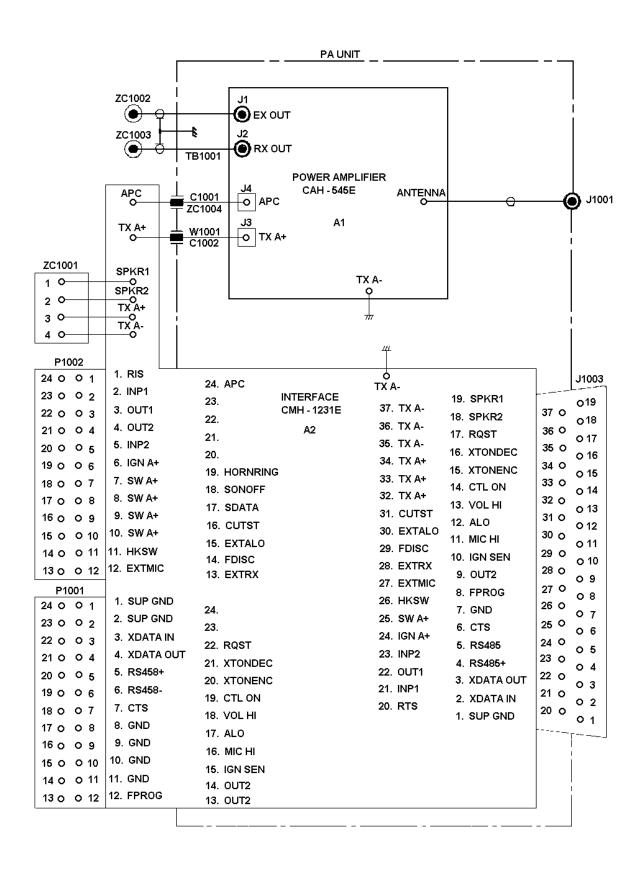
SYMBOL	PART NO.	DESCRIPTION
C34	Note: Parts listed	Mica: 90 pF ±5% 500 VDCW. (Used in P6, P7, P8).
C35	are for reference only. Refer to	Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7).
C35	Service Section for serviceable parts.	Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P8).
C36		Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60
C37		PPM. (Used in P6, P7, P8). Electrolytic: 22 μF ±10% 40 VDCW. (Used in P6, P7, P8).
C38		Ceramic: 0.1 µF +80%, -20% 50 VDCW, temp coef +30%, -80%. (Used in P6, P7, P8).
C39		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C40		Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C41		Mica: 8 pF ±0.5pF 500 VDCW. (Used in P6, P7).
C41 C41		Mica: 6 pF ±0.5pF 50 VDCW. (Used in P8). Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P3).
C41		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P4, P5).
C44		Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in P6).
C44		Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30 PPM. (Used in P7, P8).
C44		Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in P3, P4, P5).
C45		Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in P6).
C45		Ceramic: 5 pF \pm 0.5pF 50 VDCW, temp coef 0 \pm 30 PPM. (Used in P7, P8).
C47		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
and C48		
C49		Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM.
C49		(Used in P6). Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in P7).
C49		Ceramic: 2 pF ±0.25 pF, 50 VDCW, temp coef 0±30 PPM. (Used in P8).
C50		Ceramic: 4 pF ±0.25 pF, 50 VDCW, temp coef 0±30 PPM. (Used in P8).
C50		Ceramic: 6 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in P3, P4).
C50		Ceramic: 5 pF ± 0.25 pF, 50 VDCW, temp coef 0 ± 30 PPM. (Used in P5).
C51 C52		Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0±30 PPM. Ceramic: 1000 pF ±10% 50 VDCW, temp coef 0±15%.
050		(Used in P6, P7, P8).
C53 C54		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM. Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C55		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C56		Ceramic: 3 pF \pm 0.25 pF 500 VDCW, temp coef 0 \pm 120 PPM. (Used in P6, P7).
C56		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM. (Used in P3, P4, P5, P8).
C57		Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P8).
C57		Ceramic: 5 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P7)
C57		Ceramic: 7 pF ±0.5 pF 500 VDCW, temp coef 0±60 PPM. (Used in P3, P4, P5, P6).
C58		Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±120 PPM. (Used in P3, P6, P7).
C58		Ceramic: 2 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM. (Used in P4, P5, P8).
C59		Ceramic:2 pF ±0.25pF 500 VDCW, temp coef 0±250 PPM. (Used in P8). Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±120
C59 C59		PPM. (Used in P6, P7, P5). Ceramic: 5 pF ±0.25 pF 500 VDCW, temp coef 0±120 PCF = 0.25 pF ±0.25 pF 500 VDCW, temp coef 0±60
C59		PPM. (Used in P3). Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60
C60		PPM. (Used in P4). Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60
C60		PPM. (Used in P8). Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±120
C60		PPM. (Used in P6, P7). Ceramic: 6 pF ±0.25pF 500 VDCW, temp coef 0±60
C60		PPM. (Used in P3, P4). Ceramic: 7 pF ±0.5pF 500 VDCW, temp coef 0±60
000		PPM. (Used in P5).

SYMBOL	PART NO.	DESCRIPTION
C61	Note: Parts listed	Ceramic: 2 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM.
	are for reference	(Used in P3, P6, P7).
C61	only. Refer to Service Section for	Ceramic: 1 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM. (Used in P4, P5, P8).
C62	serviceable parts.	Ceramic: 7 pF ±0.5 pF 500 VDCW, temp coef 0±60 PPM.
000		(Used in P3, P4, P5, P6).
C62		Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P7, P8).
C63		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM.
C63		(Used in P3, P4, P5, P6, P7). Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM
C03		(Used in P8).
C64		Mica: 2 pF ±0.25pF 500 VDCW. (Used in P7).
C64 C64		Mica: $1.5 \text{ pF} \pm 0.25 \text{pF} 500 \text{ VDCW.}$ (Used in P8). Ceramic: $5 \text{ pF} \pm 0.25 \text{pF} 500 \text{ VDCW}$, temp coef $0\pm 60 \text{ PPM}$.
004		(Used in P3).
C64		Ceramic: 4 pF 0.25 pF 500 VDCW, temp coef 060 PPM. (Used in P4).
C64		Ceramic: 3 pF 0.25pF 500 VDCW, temp coef 0120 PPM.
		(Used in P5).
C64 C65		Mica: 3 pF ±0.25pF 500 VDCW. (Used in P6). Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM.
000		(Used in P6).
C65		Ceramic: 5 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P3).
C65		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM.
		(Used in P4, P5, P7, P8).
C66		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM. (Used in P3, P4, P7).
C66		Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM
CCC		(Used in P5). Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM.
C66		(Used in P8).
C67		Ceramic: 2 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM.
C68		(Used in P6, P7, P8). Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C69		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30
074		PPM.(Used in P6, P7, P8).
C71 C71		Tantalum: 10 μ F ±20%, 35 VDCW. (Used in P6, P7, P8). Tantalum: 10 μ F ±20% 16 VDCW. (Used in P3, P4, P5).
C72		Electrolytic: 10 μF ±10%.
C73		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C82		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C83		Tantalum: 1 μF ±20% 16 VDCW.
C84 thru		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C88		
C89		Ceramic: $0.1 \mu F \pm 5\% 25 \text{ VDCW}$. Ceramic: $100 \text{ pF} \pm 5\% 50 \text{ VDCW}$, temp coef $0\pm 30 \text{ PPM}$.
C90		(Used in P6, P7, P8).
C91		Tantalum: 4.7 μF ±10% 16 VDCW.
C92 C93		Electrolytic: 100 μF ±20% 50 VDCW. Mica: 100 pF ±5% 500 VDCW.
C95		Electrolytic: 33 μ F ±10% 25 VDCW.
C96		Ceramic: 18 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C96		(Used in P6). Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM.
		(Used in P7, P8)
C97 C98		Mica: 24 pF ±5% 100 VDCW. (Used in P8). Mica: 90 pF ±5% 500 VDCW. (Used in P6, P7, P8).
C98		Mica: 90 pF ±5% 500 VDCW. (Used in P6, P7, P8). Ceramic: 0.022 μF ±10% 50 VDCW, temp coef 0±30 PPM.
		(Used in P6).
C99		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM. (Used in P3, P4, P5).
C151		Ceramic: 330 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C151		(Used in P6, P7, P8, P3, P5) Ceramic: 7 pF ±0.5 pF 50 VDCW, temp coef 0±30 PPM.
0131		(Used in P4)
004		DIODES
CD1		Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751. (Used in P6, P7, P8)
CD2		Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.
CD3		Diode: sim to PANASONIC MA741-TX.
and CD4		
CD5		Diode. (Used in P3, P4, P5).
CD6		Diode. (Used in P6, P7, P8).
CD7 CD8		Diode. Diode. (Used in P6, P7, P8).
CD9		Diode.
CD10		Silicon: fast recovery (2 diodes in cathode common); sim to

SYMBOL	PART NO.	DESCRIPTION
CD11	Note: Desta list !	Silicon: fast recovery, (RF Switch); sim to MITSUBISHI
and	Note: Parts listed	MI301.
	are for reference	WIGOT.
CD12	only. Refer to	DE Dower Amplifier: eim to MITCURICUI METTOANA CO
HC1	Service Section for serviceable parts.	RF Power Amplifier: sim to MITSUBISHI M57704M-38. (Used in P3, P6).
HC1		RF Power Amplifier: sim to MITSUBISHI M57704H-38. (Used in P4, P7).
HC1		RF Power Amplifier: sim to MITSUBISHI M57704SH-38. (Used in P5, P8).
IC1		Linear: Positive Voltage Regulator; sim to PANASONIC AN6541.
J3		Linear, Dual OP Amp: sim to NEW JRC NJM3404AM. Connector.
J4 L1		Connector. Coil.
L2		Coil. (Used in P3, P6, P7).
L2		Coil. (Used in P4, P5, P8).
L3		Coil.
L4		Coil.
L6		Coil. (Used in P6, P7, P8).
L6		Coil. (Used in P3).
L6		Coil. (Used in P4, P5).
Lo L7		Coil. (Used in P4, P5). Coil. (Used in P6, P7, P8).
L7 L8		Coil. (Used in P6, P7, P8). Coil. (Used in P6, P7, P8).
L9		Coil. (Used in P6, P7, P8).
L10		Coil. (Used in P6, P7, P8).
L11		Coil. (Used in P6, P7, P8).
L12		Coil. (Used in P6, P7, P8).
L13		Coil. (Used in P6, P7, P8).
L14		Coil. (Used in P6, P7, P8).
L15		Coil. (Used in P6, P7).
L15		Coil. (Used in P8).
L17		Coil.
L18		Coil.
L19		Coil. (Used in P6, P7, P8).
L19		Coil. (Used in P3, P4, P5).
L20		Coil.
and		
L21		
L22		Coil.
L23		Coil. (Used in P6, P7).
and		
L24		
L23		Coil. (Used in P8).
and		
L24		
L23		Coil. (Used in P3, P4, P5).
L24		Coil. (Used in P3, P4, P5).
L25		Coil. (Used in P6, P7, P8).
P1		Coaxial cable with connector. (Used in P3, P4, P5).
P1		Coaxial cable with connector. (Used in P6, P7, P8).
P2		Coaxial cable with connector. (Used in P3, P4, P5).
P2		Coaxial cable with connector. (Used in P6, P7, P8).
· -		RESISTORS
R1		Metal film: 470 ohms ±5%, 100 VDCW 1/10W.
R2		
and		Metal film: 22 ohms ±5%, 100 VDCW 1/10W.
R3		
R4		Metal film: 470 ohms +5% 100 VDCW 1/10W
		Metal film: 470 ohms ±5%, 100 VDCW 1/10W.
R5		Metal film: 24 ohms ±5%, 350 VDCW 3W. (Used in P6, P7 P8)
D6		P8). Motal film: 3.3K ohms +5%, 250 \/DC\// 1\// (Used in P6)
R6		Metal film: 3.3K ohms ±5%, 250 VDCW 1W. (Used in P6, P7, P8)
and		P7, P8).
R7		Matal film: 24 above 140/ E00 \/ D01/4 514//1-: 11 B0
R8		Metal film: 24 ohms ±1%, 500 VDCW 1.5W. (Used in P6, P7, P8).
R10		Metal film: 82 ohms ±5%, 100 VDCW 1/8W. (Used in P6, P7, P8).
R10		Metal film: 68 ohms $\pm 5\%$, 100 VDCW 1/10W. (Used in P3, P4, P5).
R11		Metal film: 120 ohms $\pm 5\%,200$ VDCW 1/8W. (Used in P6, P7, P8).
R11		Metal film: 82 ohms $\pm 5\%,100$ VDCW 1/10W. (Used in P3, P4, P5).
R12		Metal film: 120 ohms $\pm 5\%$, 200 VDCW 1/8W. (Used in P6, P8).
R12		Metal film: 82 ohms 5%, 200 VDCW 1/8W. (Used in P7).
R12		Metal film: 100 ohms ±5%, 200 VDCW 1/10W. (Used in P3
and at		P4, P5).
and		the control of the co
R13		
		Metal film: 820 ohms ±5%, 100 VDCW 1/8W. (Used in P6,

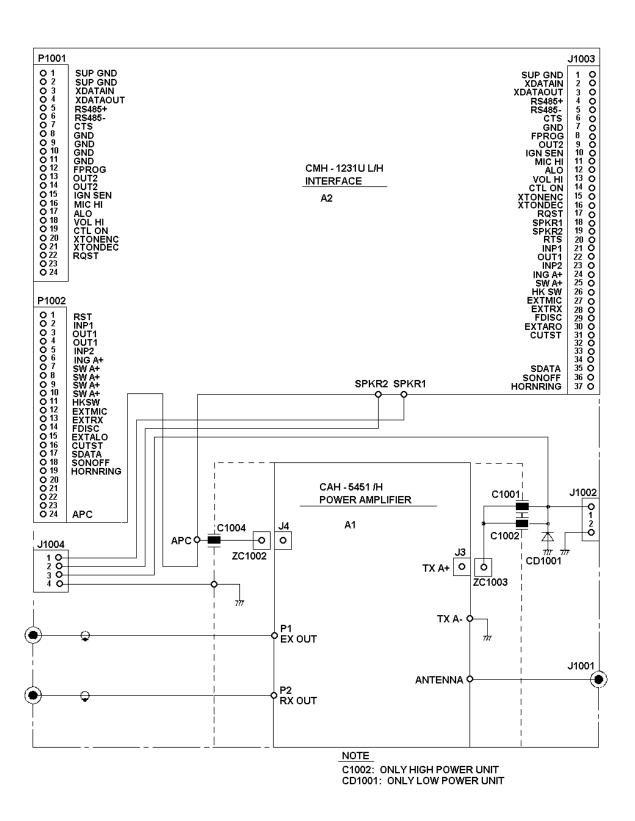
SYMBOL	PART NO.	DESCRIPTION
R14	Note: Parts listed	Metal film: 12k ohms ±5%, 100 VDCW 1/10W. (Used in P6).
R14	are for reference	Metal film: 18k ohms ±5%, 100 VDCW 1/10W. (Used in P7).
R14	only. Refer to	Metal film: 47k ohms ±5%, 100 VDCW 1/10W. (Used in P7). Metal film: 47k ohms ±5%, 100 VDCW 1/10W. (Used in P8).
R14	Service Section for	Metal film: 47k ohms ±5%, 100 VDCW 1/10W. (Used in Ps). Metal film: 2.7k ohms ±5%, 100 VDCW 1/10W. (Used in Ps,
1/14	serviceable parts.	P4,P5).
R15	our viocable parts.	Metal film: 100 ohms ±5%, 100 VDCW 1/10W.
R16		Metal film: 1.5K ohms ±5%, 100 VDCW 1/10W. (Used in
1/10		P6).
R16		Metal film: 3.9K ohms ±5%, 100 VDCW 1/10W. (Used in P7).
R16		Metal film: 4.7K ohms ±5%, 100 VDCW 1/10W. (Used in P8).
R16		Metal film: 1K ohms ±5%, 100 VDCW 1/10W. (Used in P3, P4, P5).
R17		Metal film: 120 ohms ±5%, 250 VDCW 1W. (Used in P6,
and		P7, P8).
R18		
R17		Metal film: 180 ohms ±5%, 250 VDCW 1W. (Used in P3,
and		P4, P5).
R18		
R19		Metal film: 47K ohms ±5%, 200 VDCW 1/4W.
R20		Metal film: 4.7K ohms ±5%, 100 VDCW 1/10W.
R21		Metal film: 680 ohms ±5%, 200 VDCW 1/4W.
R35		Metal film: 10K ohms ±5%, 100 VDCW 1/10W.
R36		Metal film: 3.3K ohms ±5%, 100 VDCW 1/10W.
R36		(Used in P6). Metal film: 1.8K ohms ±5%, 100 VDCW 1/10W.
R36		(Used in P7, P8). Metal film: 2.2K ohms ±5%, 100 VDCW 1/10W.
R37		(Used in P3, P4, P5). Metal film: 1.8K ohms ±5%, 100 VDCW 1/10W.
R37		(Used in P3, P6). Metal film: 2.2K ohms ±5%, 100 VDCW 1/10W.
R37		(Used in P7). Metal film: 1.5K ohms ±5%, 100 VDCW 1/10W.
R37		(Used in P4). Metal film: 1.2K ohms ±5%, 100 VDCW 1/10W.
R38		(Used in P5, P8). Metal film: 10K ohms ±5%, 100 VDCW 1/10W.
R39		(Used in P7). Metal film: 2.7K ohms ±5%, 100 VDCW 1/10W.
R39		(Used in P6, P7, P3, P4, P5). Metal film: 2.2K ohms ±5%, 100 VDCW 1/10W.
D.40		(Used in P8).
R40		Metal film: 27K ohms ±5%, 100 VDCW 1/10W.
R41		Metal film: 2.2K ohms ±5%, 100 VDCW 1/10W.
R42		Metal film: 47K ohms ±5%, 100 VDCW 1/10W.
R43		Metal film: 1K ohms ±5%, 100 VDCW 1/10W.
R44		Metal film: 820 ohms ±5%, 100 VDCW 1/10W.
and		
R45		
R46		Metal film: 470 ohms ±5%, 100 VDCW 1/10W.
and		
R47		
R48		Metal film: 10 ohms ±5%, 200 VDCW 1/8W.
R49		Polyester: sim to MURATA PTH9M04BC222TS2F333.
R50		Metal film: 100K ohms ±5%, 100 VDCW 1/10W.
R52 RV1		Metal film: 50 ohms ±5%, 100 VDCW 10W. Variable:
		TRANSISTOR
TR1		Silicon, NPN: sim to MITSUBISHI 2SC3102.
TR2		Silicon, NPN: sim to MITSUBISHI 2SC4989.
and		(Used in P6, P7, P8).
TR3		
TR4		Silicon, PNP: sim to NEC 2SB624-T1B BV3.
TR5		Silicon, PNP: sim to NEC 2SB596-T1B DV3.
and		
TR6		
TR7		Silicon PNP: sim to PANASONIC 2SB953A.
TR8		Silicon NPN: sim to PANASONIC 2SD1271-Q.
W1		Jumper wire: (Used in P6, P7, P8)
	i l	Jumper wire: (Used in P6, P7, P8)
W3		

*COMPONENTS, ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES



INTERCONNECTION DIAGRAM EUROPEAN UHF PA UNIT

(DD00-JHM-471PE)



INTERCONNECTION DIAGRAM U.S.A. UHF PA UNIT

(DD00-JHM-471PL/H)

COMPONENT IDENTIFICATION CHART 403-512 MHz 35/40-Watt Power Amplifier

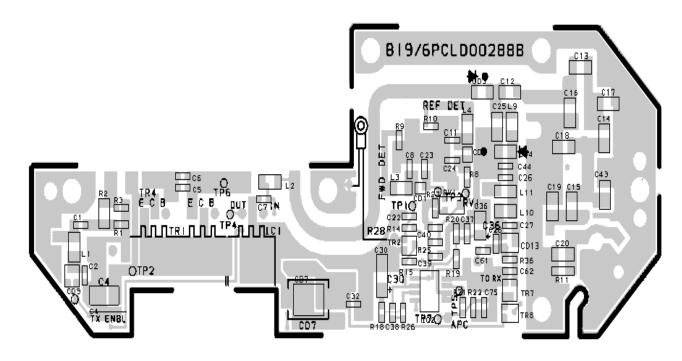
PART	CAH-545LA	CAH-545LB	CAH-545LC
	403-440 MHz (40W)	440-512 MHz (40W)	470-512 MHz (35W)
C7	12 pF	10 pF	10 pF
C9	56 pF	47 pF	47 pF
C10	56 pF	47 pF	36 pF
C11	43 pF	33 pF	39 pF
C12	39 pF	36 pF	36 pF
C13	30 pF	27 pF	22 pF
C41	12 pF	12 pF	10 pF
C50	6 pF	6 pF	5 pF
C58	3 pF	2 pF	2 pF
C59	5 pF	4 pF	3 pF
C60	6 pF	6 pF	7 pF
C61	2 pF	1 pF	1 pF
C64	5 pF	4 pF	3 pF
C65	5 pF	4 pF	4 pF
C66	4 pF	4 pF	3 pF
C67	3pF	-	-
L2	6LALD20855	6LALD20850	6LALD20850
L6	6LALD20855	6LALD20850	6LALD20850

(MADE FROM DD00-CAH-545L 2/2)

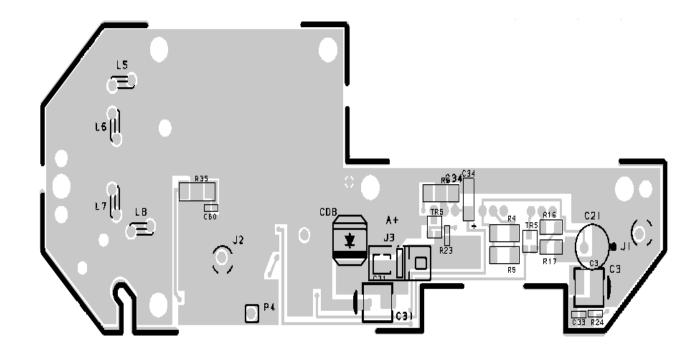
COMPONENT IDENTIFICATION CHART 403-512 MHz 80/100-Watt Power Amplifier

PART	САН-545НА	САН-545НВ	САН-545НС
	403-440 MHz (100W)	440-512 MHz (100W)	470-512 MHz (80W)
C7	12 pF	10 pF	10 pF
C9	56 pF	47 pF	47 pF
C10	56 pF	43 pF	36 pF
C11	43 pF	36 pF	33 pF
C12	43 pF	43 pF	33 pF
C13	30 pF	24 pF	- F-
C15	5 pF	5 pF	4 pF
C18	10 pF	9 pF	8 pF
C20	56 pF	47 pF	36 pF
C21	47 pF	39 pF	36 pF
C22	43 pF	36 pF	36 pF
C23	43 pF	43 pF	33 pF
C24	30 pF	27 pF	24 pF
C26	10 pF	10 pF	8 pF
C27	10 pF	9 pF	8 pF
C29	47 pF	39 pF	36 pF
C30	56 pF	47 pF	36 pF
C31	43 pF	43 pF	33 pF
C32	43 pF	36 pF	36 pF
C33	30 pF	27 pF	24 pF
C35	10 pF	10 pF	8 pF
C41	6 pF	8 pF	6 pF
C44	6 pF	5 pF	5 pF
C45	6 pF	5 pF	5 pF
C49	8 pF	7 pF	-
C50	-	-	4 pF
C56	3 pF	3 pF	4 pF
C57	7 pF	5 pF	6 pF
C58	3 pF	3 pF	2 pF
C59	3 pF	3 pF	2 pF
C60	3 pF	3 pF	4 pF
C61	2 pF	2 pF	1 pF
C62	7 pF	6 pF	6 pF
C63	4 pF	4 pF	3 pF
C64	3 pF	2 pF	1.5 pF
C65	6 pF	6 pF	4 pF
C66	-	7 pF	5 pF
C97	-	-	22 pF
R14	12kΩ	18 k Ω	$33k\Omega$
R16	3.9kΩ	3.9 k Ω	4.7 k Ω
R36	3.3kΩ	1.8 k Ω	1.8kΩ
L2	6LALD20855	6LALD20855	6LALD20855
L23	6LALD12014	6LALD12014	6LALD12013
L24	6LALD12014	6LALD12014	6LALD12013
HC1	M57704M-38	M57704H-38	M57704SH-38

(MADE FROM DD00-CAH-545H 2/2)



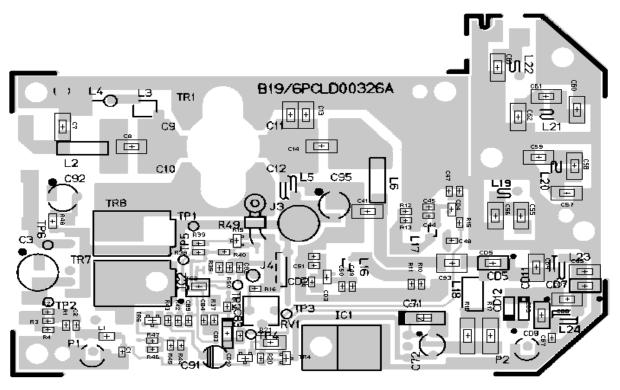
(B19/6PCLD00288B, Component Side Layout (B19/6PCLD00288B, Chip Components) (B19/6PClD00288B, Component Side)



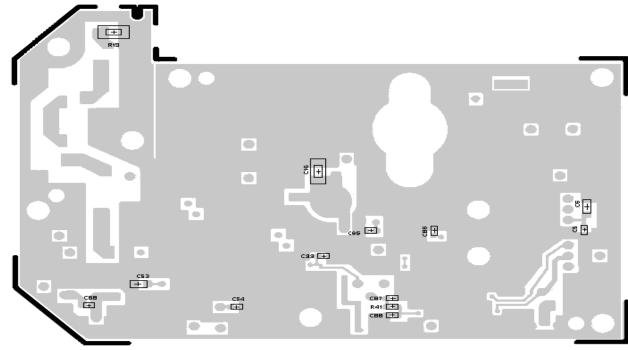
(B19/6PCLD00288B, Chip Components) (B19/6PCLD00288B, Solder Side 20-Watt Power Amplifier

CAH-545E

LBI-39164 **OUTLINE DIAGRAM**

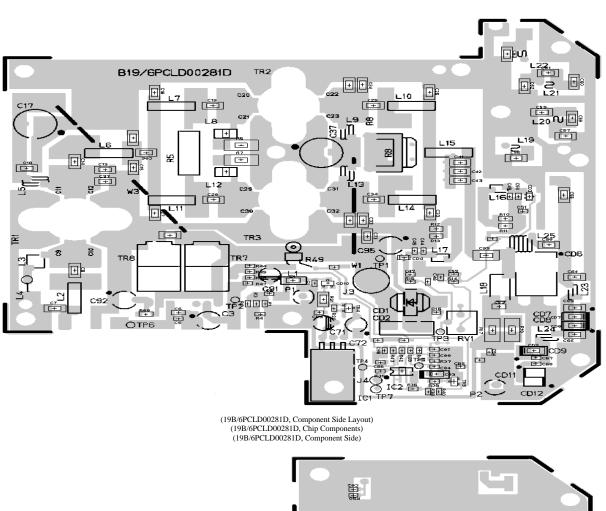


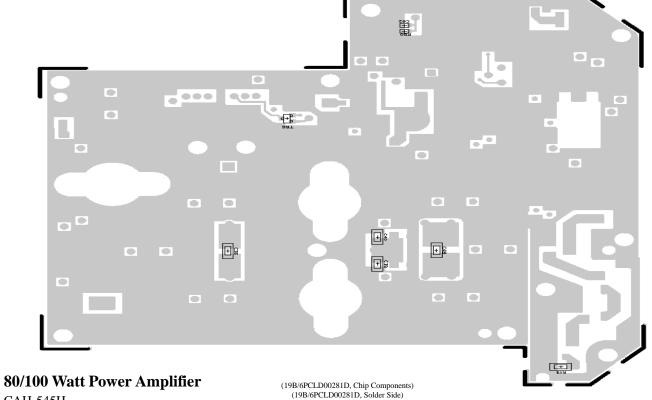
(19B/6PCLD00326A, Component Side Layout) (19B6PClD00326A, Chip Components) (19B6PLCD00326A, Component Side)



35/40 Watt Power Amplifier CAH-545L

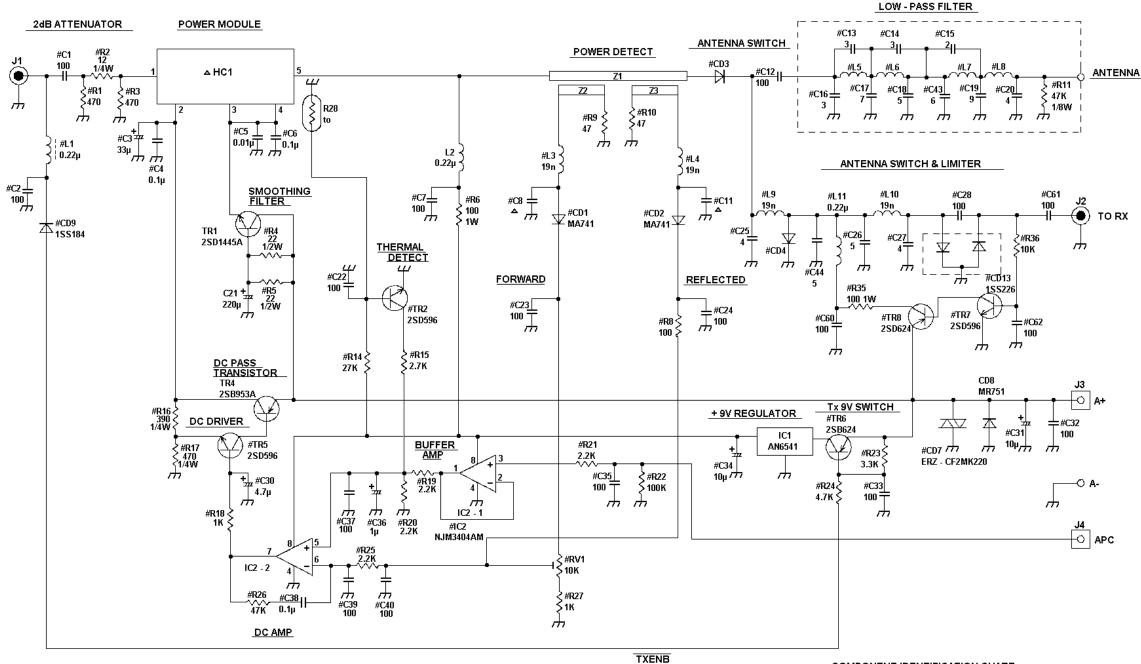
(19B/6PCLD00326A, Component Side Layout) (19B/6PCLD0032A, Chip Components) (19B/6PCLD00326A, Solder Side)





CAH-545H

SCHEMATIC DIAGRAM LBI-39164



1. "#" IDENTIFIES CHIP COMPONENTS

- (EXAMPLE #R12 OR R12#) WHICH ARE LOCATED ON THE COMPONENT SIDE OF THE BOARD.

 2. Z1, Z2 AND Z3 ARE STRIPLINE PART OF PWB.
- 3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.

ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M. CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER μ . INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR µ.

DC VOLTAGE READINGS

ALL VOLTAGES ARE TYPICAL, VOLTAGES ARE MEASURED WITH A 10Meg OHM PER VOLT METER. REFERENCE TO GROUND. VOLTAGE READINGS ARE TAKEN WITH THE TRANSMITTER UNKEYED/KEYED. EX .45 (UNKEYED)/.05 (KEYED).

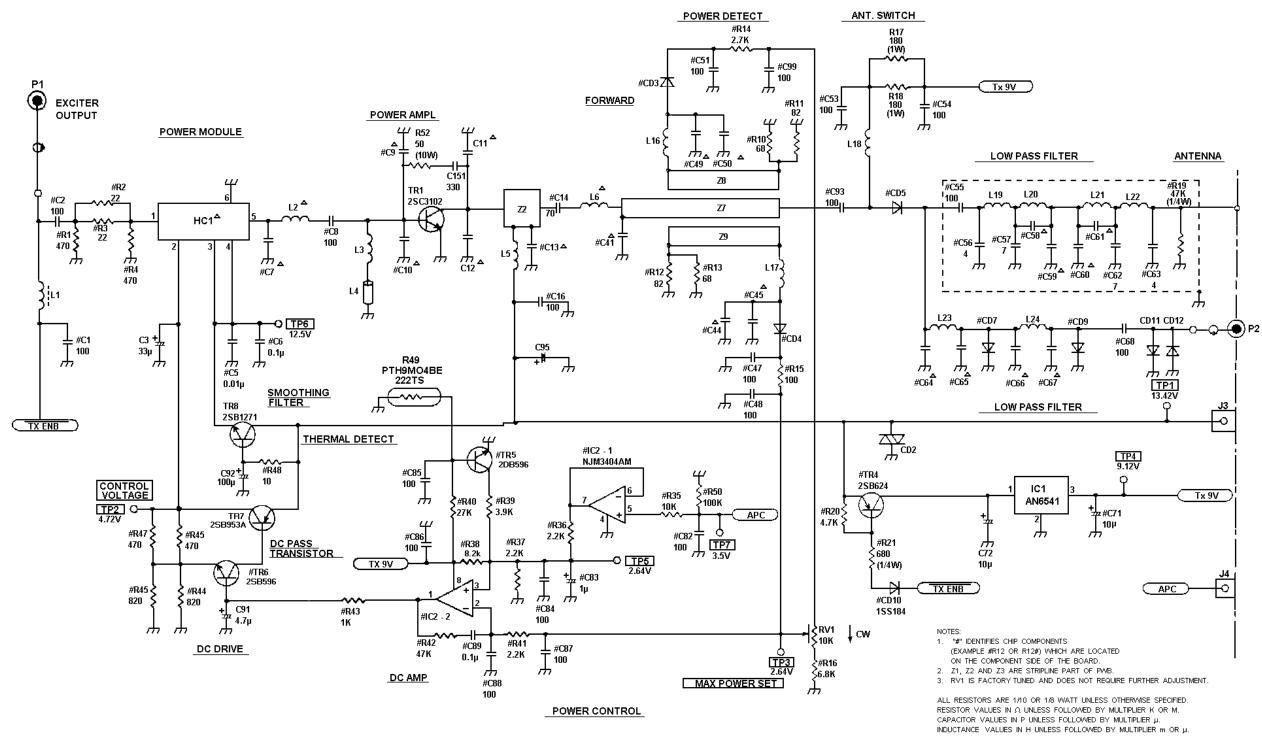
COMPONENT IDENTIFICATION CHART

PART	378 - 415 (MHz)	403 - 440 (MHz)	440 - 470 (MHz)
C8		7pF	6pF
C11		7pF	6pF
HC1	M57788SL - 38	M57788SL - 38	M57788H - 38

20 Watt Power Amplifier

CAH-545E

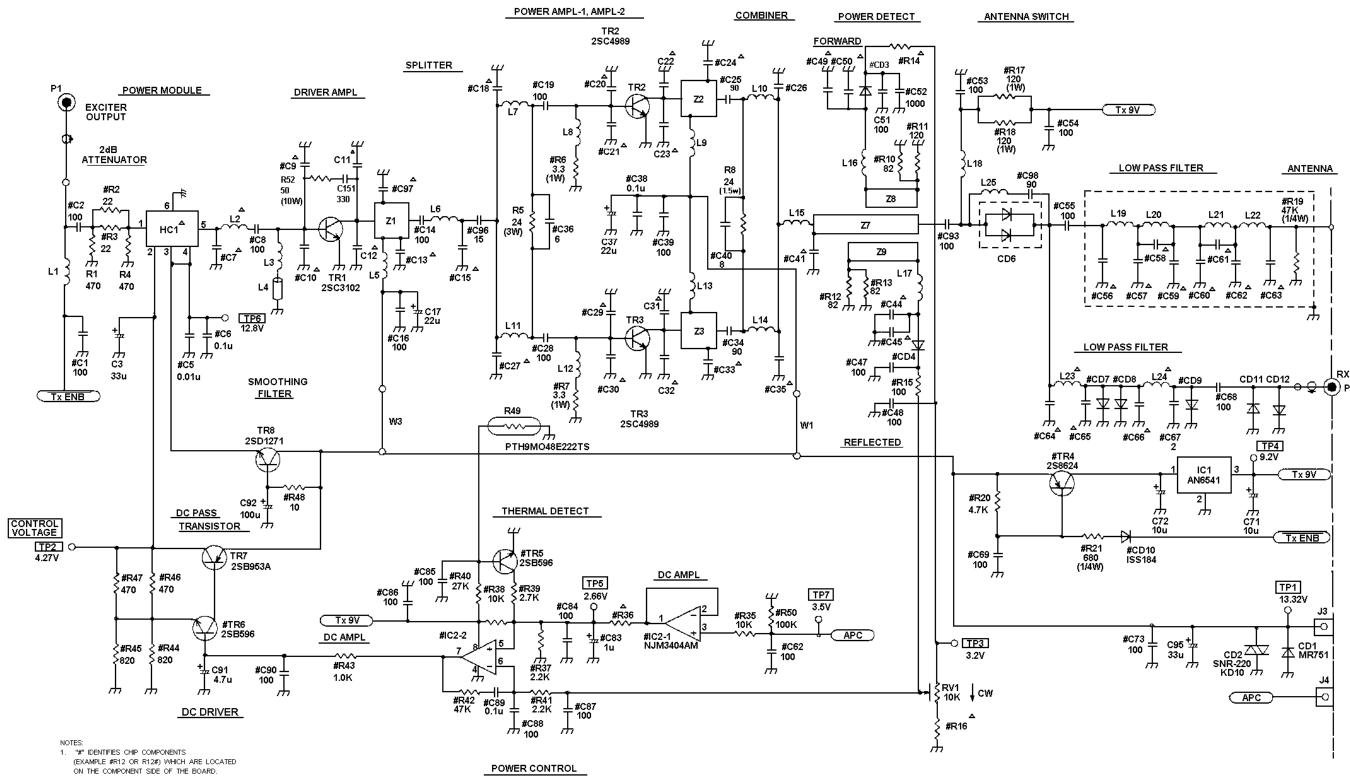
(DD00-CAH-545E)



35/40 Watt Power Amplifier

CAH-545L

(DD00-CAH-545L 1/2)



2. Z1, Z2 AND Z3 ARE STRIPLINE PART OF PWB.

3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.

ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M. CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER $\mu.$ INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR $\mu.$

80/100 Watt Power Amplifier

CAH-545H

(DD00-CAH-545H 1/2)